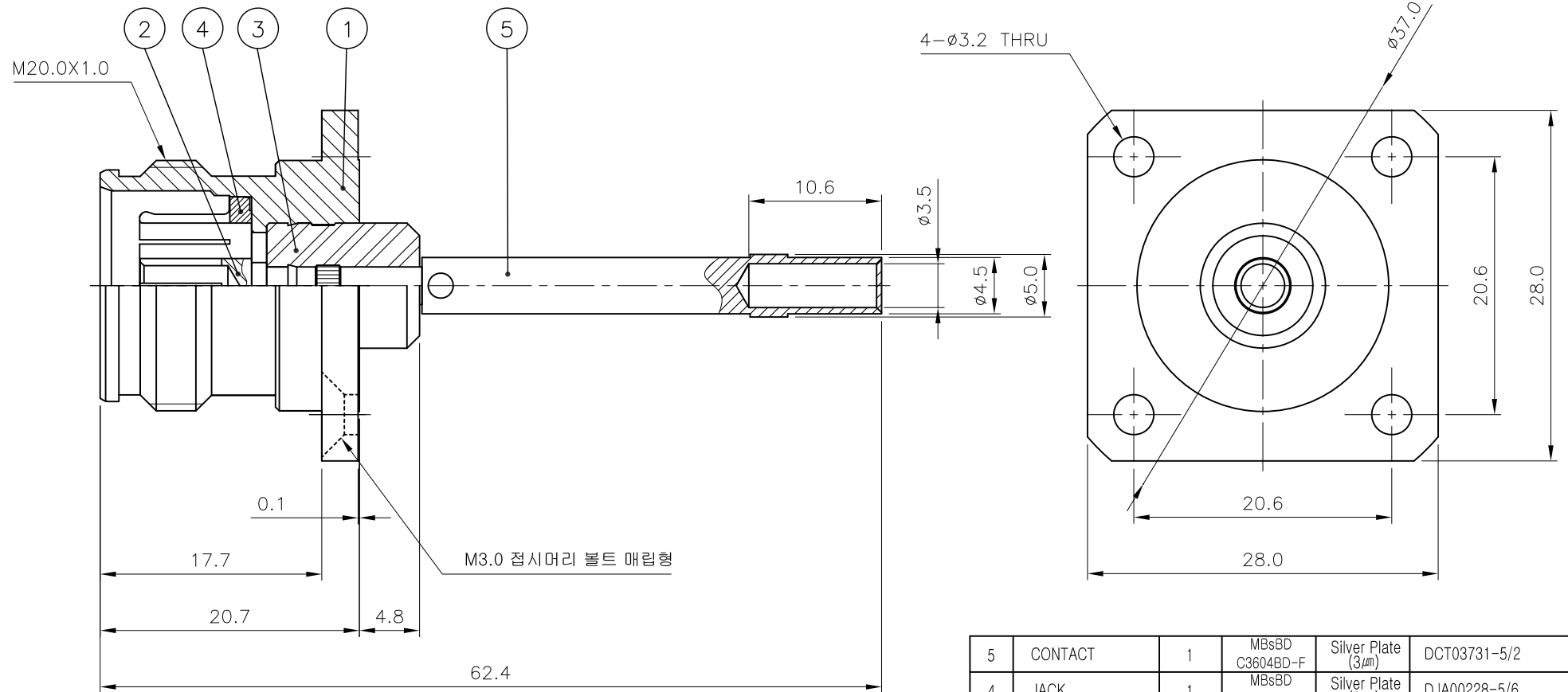


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
1	Initial Registration	T.J.KIM	J.H.YOUN	2016. 07. 19.	
2	형상 및 길이 변경	S.L.SON	J.H.YOUN	2016. 11. 25.	
3	PIN 형상 변경	S.L.SON	J.H.YOUN	2019. 08. 07.	



5	CONTACT	1	MBsBD C3604BD-F	Silver Plate (3μm)	DCT03731-5/2
4	JACK	1	MBsBD C3604BD-F	Silver Plate (3μm)	DJA00228-5/6
3	INSULATOR	1	TEFLON		DIN02919-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (5μm)	DCT03729-5/2
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (3μm)	DBD04187-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2016. 11. 25.		 KJ COMTECH CO.,LTD.	RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY J.H.YOUN	CHECKED BY T.J.KIM		
MATERIAL _____		DRAWN BY S.L.SON	TITLE 4.3-10 DC BLOCK JS-4H		
FINISH _____	SCALE 2/1	UNIT mm		DWG NO. CN03635-7/3 REVISION 3	SHEET 1 of 1